

<SPECIFICATION>

SPEC.No. ASDIQ-SPE-117(00)

Date: Aug.27,2022

To :

CUSTOMER'S PRODUCT NAME

ASDI PRODUCT NAME: SPUI75N-SERIES

RECEIPT CONFIRMATION

UNCONDITIONAL CONSENT

CONDITIONAL CONSENT

APPROVED	CHECKED

ASDI SIGNATURE

APPROVED	CHECKED	PREPARED
Xianglong Li	Liang Wang	Jiayin Cai



Xiamen ASDI Electronics Co.,Ltd.

CAUTION WHEN HANDLING

Before use the products, please read this specification.

CAUTION FOR SAFETY USING

When use the products, be careful to mentioned below for safety using.

CAUTION

*The product should be used within 12 monthes.

Focus on the storage conditions.

Solderability may become weak if it exceeds the period.

*Do not use and store the product in condition of gas corrosion
(Salt,Acid,Alkaline).

*The products must be preheated before soldering.

The operating temperature including self-generated heat must be within '-40~+125℃

*Rework by soldering iron;Please keep the mentioned conditions in this specification.

*In case of insert P.C. Board on chassis, do not add mechanical stress to the product.

*Be careful to arrange of non-magnetic field type inductors.

The error may be caused by magnetic field coupling.

*In case handle the products, please use wrist strap for ground static discharge on human body.

The product keeps away from magnet or magnetized things.

*Do not use the product beyond the mentioned conditions in this specification.

*About an application

The products listed on this specification sheet are intended for use in general electronic equipment

(AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

*The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

- | | |
|--------------------------------|---|
| 1)Aerospace/Aviation equipment | 6)Transportation control equipment |
| 2)Military equipment | 7)Power-generation control equipment |
| 3)Seabed equipment | which directly endanger human life |
| 4)Safety equipment | 8)Atomic energy-related equipment |
| 5)Medical equipment | 9)Other applications that are not |
| | considered general-purpose applications |

If you intend to use the products in the following applications, please contact our sales office.

Transportation equipment (cars, electric trains, ships, etc.), Public information-processing equipment, Electric heating apparatus / burning equipment, Disaster prevention/crime prevention equipment

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.

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ISSUE

CUSTOMER

ASDI PART No.
SPUI75N-SERIES

CUSTOMER'S DWG NO.

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2.Manufacturing Location

China

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(1)Features

- 1.Small and Low profile inductor
- 2.It corresponds to high current.
- 3.Simple and Shield structure.
- 4.Available tape and reel for auto insertion.
- 5.100% Lead(Pb)-Free and RoHS compliant.

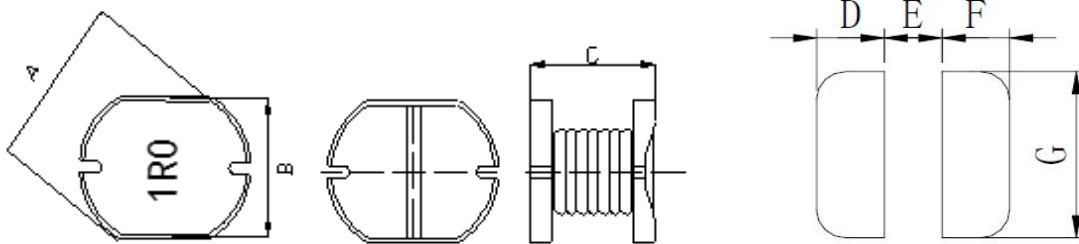


(2)Applications

-For small DC/DC converter(cellular phone,LCD/LED/OLED display, HDD, DSC etc)

(3)Dimensions

Recommend Land pattern



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	F(mm)	G(mm)
SPUI75N	7.8±0.3	7.0±0.3	5.0±0.4	3.0	2.0	3.0	7.5

(4)Part Numbering

SPUI **75** **N** - **1R0** **M**
 A B C D E

A: Series
 B: Dimension
 C: Type

D: Inductance

E: Inductance Tolerance

1R0=1.0μH, 100=10μH, 101=100μH, 102=1000μH

K=±10% M=±20%

marking direction cannot decide polarity. Color: Black, unidirectional.

No magnetic shielding

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(5)Electrical Specification

ASDI Part Number	Inductance		Tolerance	Frequency (Hz/0.25V)	Rated current		DCR
	L0 (uH)				Saturation current I sat (A)	Temperature current I rms (A)	(mΩ) @25℃
	@ 0 A						±20%.
SPUI75N-1R0M	1.00		±20%	100K	8.50	8.00	10.0
SPUI75N-1R5M	1.50		±20%	100K	5.80	4.50	25.0
SPUI75N-2R2M	2.20		±20%	100K	5.50	4.15	25.0
SPUI75N-3R3M	3.30		±20%	100K	5.10	3.85	30.0
SPUI75N-4R7M	4.70		±20%	100K	4.70	3.50	38.0
SPUI75N-5R6M	5.60		±20%	100K	4.15	3.20	45.0
SPUI75N-6R8M	6.80		±20%	100K	3.75	2.80	48.0
SPUI75N-8R2M	8.20		±20%	100K	3.60	2.50	49.0
SPUI75N-100M	10.00		±20%	100K	3.50	2.10	50.0
SPUI75N-150M	15.00		±20%	100K	2.75	1.75	100
SPUI75N-220M	22.00		±20%	100K	2.40	1.50	120
SPUI75N-330K,M	33.00		±10%/±20%	100K	1.80	1.30	150
SPUI75N-470K,M	47.00		±10%/±20%	100K	1.60	1.10	200
SPUI75N-680K,M	68.00		±10%/±20%	100K	1.15	0.80	300
SPUI75N-101K	100.0		±10%	100K	0.87	0.65	450
SPUI75N-121K	120.0		±10%	100K	0.73	0.60	490
SPUI75N-151K	150.0		±10%	100K	0.58	0.45	640
SPUI75N-181K	180.0		±10%	100K	0.70	0.55	730
SPUI75N-221K	220.0		±10%	100K	0.65	0.47	1000
SPUI75N-331K	330.0		±10%	100K	0.57	0.40	1450
SPUI75N-471K	470.0		±10%	100K	0.43	0.32	2050
SPUI75N-561M	560.0		±20%	100K	0.40	0.31	2400
SPUI75N-681K	680.0		±10%	100K	0.38	0.30	2900
SPUI75N-821K	820.0		±10%	100K	0.30	0.28	3250
SPUI75N-102K	1000.0		±10%	100K	0.30	0.26	3500
SPUI75N-152K	1500.0		±10%	100K	0.15	0.20	5300
			K±10%	M±20%			

Note:

- All test data referenced to 25℃ ambient.
- Testing Instrument : L/Q: HP4284A,CH11025,CH3302,CH1320 ,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER.
- Heat Rated Current (Irms) will cause the coil temperature rise approximately Δt of 40℃ (keep 1min.).
- Saturation Current (Isat) will cause L0 to drop 30% typical. (keep quickly).
- The part temperature (ambient + temp rise) should not exceed 125℃ under worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- Special inquiries besides the above common used types can be met on your requirement.

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(6)Structure and Components

No.	Components	Material
1	Core	Ferrite core.
2	Wire	Polyester Wire or equivalent.
3	Ink	Halogen-free ketone



(7)Reliability Tests

No.	Test item	Performance	Test details	
1	Operating temperature	-40~+125℃		
2	Storage Temperature	-10~+40℃,50~60%RH (Product without taping)		
Electrical Performance Test				
3	Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320SLCR Meter.	
4	DCR		CH16502,Agilent33420A Micro-Ohm Meter.	
5	Saturation Current (Isat)	ΔL30% typical.	Saturation DC Current (Isat) will cause L0 to drop ΔL%(keep quickly).	
6	Heat Rated Current (Irms)	Approximately ΔT≤40℃	Heat Rated Current (Irms) will cause the coil temperature rise ΔT(℃) without core loss. 1.Applied the allowed DC current(keep 1 min.). 2.Temperature measured by digital surface thermometer	
Reliability Test				
7	High Temperature Exposure Test	Electric specifications should be satisfied	Temperature:125±2℃. Duration:1000±12hrs. Measured at room temperature after placing for 2 to 3hrs. (MIL-PRF-27)	
8	Low Temperature Life Test		Temperature: -40±2℃. Duration:500±12hrs. Measured at room temperature after placing for 2 to 3hrs.	
9	Biased Humidity Test		Humidity:85±3%RH. Temperature:85±2℃. Duration:1000±12hrs. Measured at room temperature after placing for 2 to 3hrs (AEC-Q200-REV C)	
10	Thermal shock test		Condition for 1 cycle Step1:-40+0 / -2℃ 15±1 min. Step2:Room temperature within ≤0.2 min. Step3:+125+2 / -0℃ 15±1min. Number of cycles:300 Measured at room temperature after placing for 2 to 3 hrs. (AEC-Q200-REV C)	
11	Vibration test		Frequency: 10-2000-10Hz for 20 min. Amplitude: Parts mounted within 2" from any secure point. Directions and times: X, Y, Z directions for 20 min. This cycle shall be performed 12 times in each of three mutually perpendicular directions(Total 12 hours). (MIL-STD-202 Method 204 D Test condition B)	
12	Reflow test		Pre-heat: 150±5℃ Duration: 5 minutes Temperature: 260±5℃, 20~40 seconds (IPC/JEDEC J-STD-020C)	
13	Solder test		Terminals should be covered by over 95% solder on visual inspection	After dip into flux, dip into solder 235±5℃, 4±1seconds Flux \ solder for lead free (ANSI /J-STD-002C Method B)

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(8)Soldering and Mounting
 8-1,Soldering

Mildly activated rosin fluxes are preferred.
 The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate.
 ASDI terminations are suitable for re-flow soldering systems.
 If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

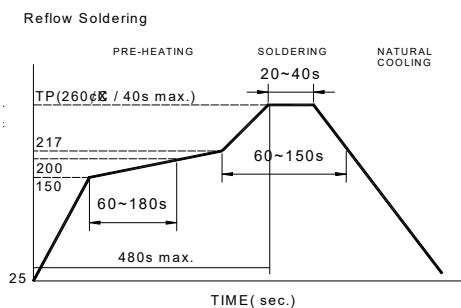
8-2,Solder re-flow

Recommended temperature profiles for re-flow soldering in Figure 1.

8-3,Soldering Iron

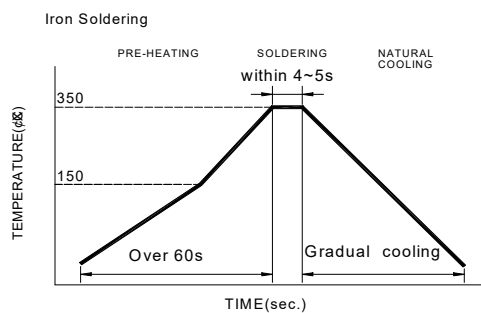
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 355°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4-5sec.



Reflow times: 3 times

Fig.1



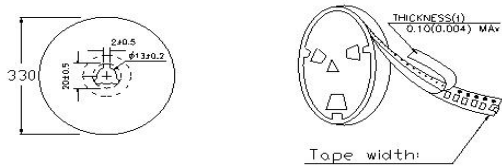
Iron Soldering times: 1 times

Fig.2

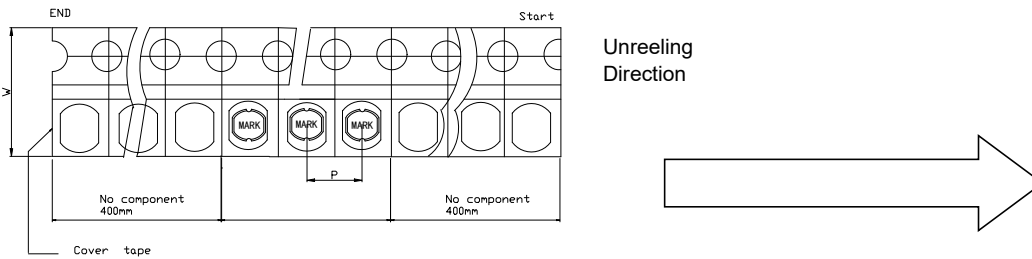
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(9)Packaging Information

9-1,Reel Dimension



9-2,Tape Dimension

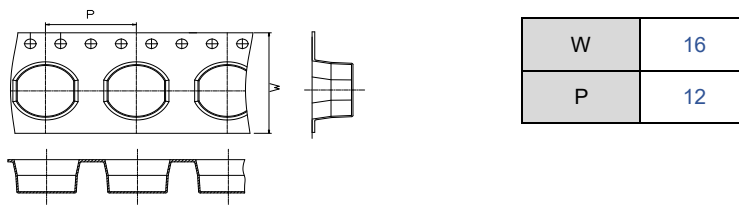


Note: After the tape is woven, the outermost layer of the reel is 400mmMIN, and the innermost layer is 400mmMIN.

9-3,Packaging Quantity

SPII	75
Chip / Reel	1000

9-4,Carrier Tape Dimensions(mm)



(10)Note

·Storage Conditions

To maintain the solderability of terminal electrodes:

1. ASDI products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
2. Temperature and humidity conditions: Temperature: 5 to 30deg.C, Humidity: 75% Max.
3. Recommended products should be used within 12 months form the time of delivery.
4. The packaging material should be kept where no chlorine or sulfur exists in the air.

·Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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单击下面可查看定价，库存，交付和生命周期等信息

[>>ASDI](#)